

Industrial Grade Multilayer Ceramic Chip Capacitors

B0201X6S104K6R3NTA (0201,X6S,100 nF,DC 6.3 V)

1. Scope

This specification applies to high-reliability applications such as industrial control, communication base stations, and commercial equipment. specific scenarios include: communication power supplies, industrial power supplies, medical equipment, cloud services, and 48V high-efficiency power distribution architectures required for high-performance computing; systems utilizing wide-bandgap (SiC, GaN) power devices.

2. Part Number System

|             |           |                             |                     |                       |               |                  |                |                |
|-------------|-----------|-----------------------------|---------------------|-----------------------|---------------|------------------|----------------|----------------|
| B           | 0201      | X6S                         | 104                 | K                     | 6R3           | N                | T              | A              |
| ①           | ②         | ③                           | ④                   | ⑤                     | ⑥             | ⑦                | ⑧              | ⑨              |
| Series Code | Size Code | Temperature Characteristics | Nominal Capacitance | Capacitance Tolerance | Rated Voltage | Termination Type | Packaging Code | Thickness Code |

① Series Code B - Industrial Grade Multilayer Ceramic Chip Capacitors

② Size Code (Unit: mm)

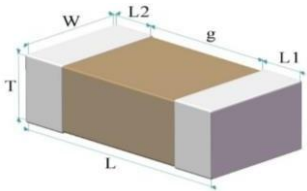


Fig.1: Structure & Dimension

| Size Code | L           | W           | L1,L2     | g        | T           | ⑨ Thickness Code |
|-----------|-------------|-------------|-----------|----------|-------------|------------------|
| 0201      | 0.60 ± 0.03 | 0.30 ± 0.03 | 0.10-0.20 | 0.20 min | 0.30 ± 0.03 | A                |

③ Temperature Characteristics

| Temperature Characteristics | Operating Temp. Range | Temperature Characteristics |               |            |
|-----------------------------|-----------------------|-----------------------------|---------------|------------|
|                             |                       | Temp. coeff. or Cap. Change | Temp. Range   | Ref. Temp. |
| X6S                         | -55 °C-105 °C         | ±22%                        | -55 °C-105 °C | 25 °C      |

④ Nominal Capacitance

| Code | Nominal Capacitance |
|------|---------------------|
| 104  | 100 nF              |

⑤ Capacitance Tolerance

| Code | Capacitance Tolerance |
|------|-----------------------|
| K    | ±10%                  |

⑥ Rated Voltage

| Code | Voltage Values |
|------|----------------|
| 6R3  | DC 6.3V        |

⑦ Termination Type

| Code | Terminal Electrodes | Plating Material |
|------|---------------------|------------------|
| N    | Cu                  | Ni/Sn            |

⑧ Packaging Code

| Packaging Code | Square Hole Spacing | Disc Size | Carrier Tape | QTY (Kpcs) |
|----------------|---------------------|-----------|--------------|------------|
| T              | 2 mm                | 7 //      | Paper        | 15         |

## 3. Technical Specifications and Test Methods

## 1. Operating Environment

| Temp. Characteristics | Temp. Range   | Relative Humidity | Atmospheric Pressure |
|-----------------------|---------------|-------------------|----------------------|
| X6S                   | -55 °C-105 °C | ≤95% (25 °C)      | 86 Kpa-106 KPa       |

## 3.2 Reliability Test Specifications and Methods

Unless otherwise specified, the test methods in Table 1 are based on: GB/T 21041 and GB/T 21042 (IDT IEC 6038)

Table 1: Specifications and Methods

| No. | Item                                      | Specification                                       | Test Method                                                                                                                                                                                                                                                                                                                                                                                                                    |
|-----|-------------------------------------------|-----------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1   | Appearance                                | No obvious defects on ceramic body and termination. | Visual examination under a microscope                                                                                                                                                                                                                                                                                                                                                                                          |
| 2   | Size Code                                 | See Fig.1 and ② Size Code                           | Measuring by gages which precision is not less than 0.01 mm.                                                                                                                                                                                                                                                                                                                                                                   |
| 3   | Capacitance                               | Within the specified tolerance                      | Measurement Temperature 18 °C-28 °C<br>Relative Humidity ≤RH 80%                                                                                                                                                                                                                                                                                                                                                               |
| 4   | Dissipation Factor (DF)                   | See Table 1-2                                       | Measurement Frequency See Table 1-2<br>Measurement Voltage See Table 1-2<br>Post-treatment When the capacitor initial capacitance is lower than its tolerance value, the test sample need to perform a heat treatment at 150 °C + 0/-10 °C for 1hour and then sit for 24 ± 2 hours at room temperature, then measure.                                                                                                          |
| 5   | Insulation Resistance (IR)                | See Table 1-2                                       | Measurement Temperature 18 °C-28 °C<br>Relative Humidity ≤RH 80%<br>Measurement Voltage Rated Voltage<br>Charging Time 1 min<br>Charge/discharge current ≤50 mA                                                                                                                                                                                                                                                                |
| 6   | Voltage proof                             | No defects or abnormalities.                        | Test Voltage $\geq 2.5 \times U_R$<br>Applied Time $t = 1 \sim 5 \text{ s}$<br>Charge/discharge current ≤50 mA                                                                                                                                                                                                                                                                                                                 |
| 7   | Temperature characteristic of capacitance | X6S: $\Delta C/C \leq \pm 22\%$                     | Pre-treatment Perform a heat treatment at 150 °C + 0/-10 °C for 1hour and then sit for 24 ± 2 hours at room temperature.then measure.<br>Measure the capacitance separately in 25°C、θ1、25°C、θ2、25°C, should satisfied related Temperature Coefficient of Capacitance ( $\alpha_C$ ) .<br>X6S θ1=-55 °C, θ2=105 °C<br>T.C. Measurement Voltage ≤1.0 Vrms ※ [※ Please contact our technical support staff for more information.] |

Table 1: Specifications and Methods

| No. | Item                             | Specification                | Test Method                                                                                                                                                             |
|-----|----------------------------------|------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 8   | Resistance to soldering heat     | Appearance                   | No visible damage and terminations uncovered shall be less than 25%.                                                                                                    |
|     |                                  | Cap. Change                  | See Table 1-3                                                                                                                                                           |
|     |                                  | IR                           | Initial specification                                                                                                                                                   |
|     |                                  | DF                           | Initial specification                                                                                                                                                   |
|     |                                  | Voltage proof                | No defects or abnormalities.                                                                                                                                            |
|     |                                  | Pre-treatment                | Perform a heat treatment at $150\text{ }^{\circ}\text{C} + 0/-10\text{ }^{\circ}\text{C}$ for 1hour and then sit for $24 \pm 2$ hours at room temperature.then measure. |
|     |                                  | Pre-heating                  | $120\text{ }^{\circ}\text{C}$ - $150\text{ }^{\circ}\text{C}$ ,Time: 60 s                                                                                               |
|     |                                  | Test Method                  | Solder bath method                                                                                                                                                      |
| 9   | Solderability                    | Solder alloy                 | Sn-Ag-Cu (Lead Free Solder)                                                                                                                                             |
|     |                                  | Temperature                  | $(270 \pm 5)\text{ }^{\circ}\text{C}$                                                                                                                                   |
|     |                                  | Duration of immersion        | $(10 \pm 1)\text{ s}$                                                                                                                                                   |
|     |                                  | Depth of immersion           | 10 mm                                                                                                                                                                   |
|     |                                  | Post-treatment               | Let sit for $24 \pm 2$ hours at room temperature, then measure.                                                                                                         |
|     |                                  | Appearance                   | 95% of the terminations is to be soldered evenly and continuously                                                                                                       |
|     |                                  | Pre-heating                  | $80\text{ }^{\circ}\text{C}$ - $120\text{ }^{\circ}\text{C}$ ,Time: 10-30 s                                                                                             |
|     |                                  | Test Method                  | Solder bath                                                                                                                                                             |
| 10  | Substrate bending test           | Flux                         | Solution of rosin ethanol                                                                                                                                               |
|     |                                  | Solder alloy                 | Sn-Ag-Cu (Lead Free Solder)                                                                                                                                             |
|     |                                  | Temperature                  | $(245 \pm 5)\text{ }^{\circ}\text{C}$                                                                                                                                   |
|     |                                  | Duration of immersion        | $(2.0 \pm 0.5)\text{ s}$                                                                                                                                                |
|     |                                  | Depth of immersion           | 10 mm                                                                                                                                                                   |
|     |                                  | Appearance                   | No defects or abnormalities                                                                                                                                             |
|     |                                  | Cap. Change                  | See Table 1-3                                                                                                                                                           |
|     |                                  | Mounting method              | Solder the capacitor on the test substrate as shown in Fig 2                                                                                                            |
| 11  | Adhesive strength of termination | Pressurization Method        | as shown in Fig 3                                                                                                                                                       |
|     |                                  | Flexure                      | 1 mm                                                                                                                                                                    |
|     |                                  | Holding Time                 | $(5 \pm 1)\text{ s}$                                                                                                                                                    |
|     |                                  | then measure the capacitance |                                                                                                                                                                         |
|     |                                  | Appearance                   | No defects or abnormalities                                                                                                                                             |
|     |                                  | Mounting method              | Solder the capacitor to the test substrate and apply the normal force F indicated in Fig. 4                                                                             |
|     |                                  | Holding Time                 | $t = 10 \pm 1\text{ s}$                                                                                                                                                 |
|     |                                  | Pushing force                | 0201:F = 2 N                                                                                                                                                            |

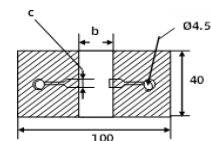


Fig. 2

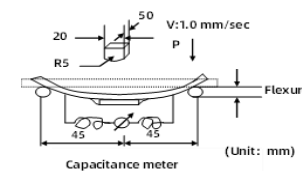


Fig. 3

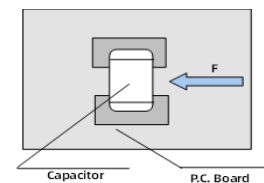


Fig. 4

Table 1: Specifications and Methods

| No.           | Item                                    | Specification  |                                                             | Test Method                                                                     |                                                                                                                                                                                                                                                        |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|---------------|-----------------------------------------|----------------|-------------------------------------------------------------|---------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|------|-----------|------------|---|-----|------|---|----|-----|---|-----|------|---|----|-----|
| 12            | Vibration                               | Appearance     | No defects or abnormalities                                 | Mounting method                                                                 | Solder the capacitor on the test substrate                                                                                                                                                                                                             |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         | Cap. Change    | See Table 1-3                                               | Amplitude                                                                       | 1.5 mm                                                                                                                                                                                                                                                 |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         | IR             | Initial specification                                       | Kind of Vibration                                                               | A simple harmonic motion                                                                                                                                                                                                                               |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         | DF             | Initial specification                                       | Frequency                                                                       | 10 Hz-55 Hz-10 Hz                                                                                                                                                                                                                                      |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         |                |                                                             | Vibration Time                                                                  | 1 min                                                                                                                                                                                                                                                  |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         |                |                                                             | Repeat this for 2hrs each in 3 perpendicular directions X, Y, Z, total 6 hours. |                                                                                                                                                                                                                                                        |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         |                |                                                             |                                                                                 |                                                                                                                                                                                                                                                        |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
| 13            | Rapid change of temperature             | Appearance     | No defects or abnormalities                                 | Pre-treatment                                                                   | Perform a heat treatment at 150 °C + 0/-10 °C for 1hour and then sit for 24 ± 2 hours at room temperature.then measure.                                                                                                                                |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         | Cap. Change    | See Table 1-3                                               | Mounting method                                                                 | Solder the capacitor on the test substrate                                                                                                                                                                                                             |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         | IR             | Initial specification                                       | The number of cycles                                                            | 100 cycles                                                                                                                                                                                                                                             |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         | DF             | Initial specification                                       | Temperature Step                                                                | <table><tr><td>Step</td><td>Temp.(°C)</td><td>Time (min)</td></tr><tr><td>1</td><td>-55</td><td>30±3</td></tr><tr><td>2</td><td>25</td><td>2-5</td></tr><tr><td>3</td><td>105</td><td>30±3</td></tr><tr><td>4</td><td>25</td><td>2-5</td></tr></table> |  |  | Step | Temp.(°C) | Time (min) | 1 | -55 | 30±3 | 2 | 25 | 2-5 | 3 | 105 | 30±3 | 4 | 25 | 2-5 |
|               |                                         | Step           | Temp.(°C)                                                   | Time (min)                                                                      |                                                                                                                                                                                                                                                        |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         | 1              | -55                                                         | 30±3                                                                            |                                                                                                                                                                                                                                                        |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         | 2              | 25                                                          | 2-5                                                                             |                                                                                                                                                                                                                                                        |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
| 3             | 105                                     | 30±3           |                                                             |                                                                                 |                                                                                                                                                                                                                                                        |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
| 4             | 25                                      | 2-5            |                                                             |                                                                                 |                                                                                                                                                                                                                                                        |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
| Voltage proof | No defects or abnormalities.            | Post-treatment | Let sit for 24 ± 2 hours at room temperature, then measure. |                                                                                 |                                                                                                                                                                                                                                                        |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         |                |                                                             |                                                                                 |                                                                                                                                                                                                                                                        |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         |                |                                                             |                                                                                 |                                                                                                                                                                                                                                                        |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
| 14            | Damp heat, steady state                 | Appearance     | No defects or abnormalities                                 | Pre-treatment                                                                   | Perform a heat treatment at 150 °C + 0/-10 °C for 1hour and then sit for 24 ± 2 hours at room temperature.then measure.                                                                                                                                |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         | Cap. Change    | See Table 1-3                                               | Mounting method                                                                 | Solder the capacitor on the test substrate                                                                                                                                                                                                             |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         | IR             | See Table 1-3                                               | Test Temperature                                                                | 60 °C ± 2 °C                                                                                                                                                                                                                                           |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         | DF             | See Table 1-3                                               | Test Humidity                                                                   | RH 90–95%                                                                                                                                                                                                                                              |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         |                |                                                             | Test Time                                                                       | 500 ± 12 h                                                                                                                                                                                                                                             |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         |                |                                                             | Post-treatment                                                                  | Let sit for 24 ± 2 hours at room temperature, then measure.                                                                                                                                                                                            |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         |                |                                                             |                                                                                 |                                                                                                                                                                                                                                                        |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
| 15            | High temperature high humidity (steady) | Appearance     | No defects or abnormalities                                 | Pre-treatment                                                                   | Perform a heat treatment at 150 °C + 0/-10 °C for 1hour and then sit for 24 ± 2 hours at room temperature.then measure.                                                                                                                                |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         | Cap. Change    | See Table 1-3                                               | Mounting method                                                                 | Solder the capacitor on the test substrate                                                                                                                                                                                                             |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         | IR             | See Table 1-3                                               | Test Temperature                                                                | 60 °C ± 2 °C                                                                                                                                                                                                                                           |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         | DF             | See Table 1-3                                               | Test Humidity                                                                   | RH 90–95%                                                                                                                                                                                                                                              |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         |                |                                                             | Test Voltage                                                                    | 1.0 × U <sub>R</sub>                                                                                                                                                                                                                                   |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         |                |                                                             | Test Time                                                                       | 500 ± 12 h                                                                                                                                                                                                                                             |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         |                |                                                             | Charge/discharge curren                                                         | ≤ 50 mA                                                                                                                                                                                                                                                |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         |                |                                                             | Post-treatment                                                                  | Perform a heat treatment at 150 °C + 0/-10 °C for 1hour and then sit for 24 ± 2 hours at room temperature. then measure.                                                                                                                               |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |
|               |                                         |                |                                                             |                                                                                 |                                                                                                                                                                                                                                                        |  |  |      |           |            |   |     |      |   |    |     |   |     |      |   |    |     |

Table 1: Specifications and Methods

| No. | Item      | Specification |                             | Test Method             |                                                                                                                          |
|-----|-----------|---------------|-----------------------------|-------------------------|--------------------------------------------------------------------------------------------------------------------------|
| 16  | Endurance | Appearance    | No defects or abnormalities | Pre-treatment           | Perform a heat treatment at 150 °C + 0/-10 °C for 1hour and then sit for 24 ± 2 hours at room temperature. then measure. |
|     |           | Cap. Change   | See Table 1-3               | Mounting method         | Solder the capacitor on the test substrate                                                                               |
|     |           | IR            | See Table 1-3               | Test Temperature        | 105 °C ± 3 °C                                                                                                            |
|     |           | DF            | See Table 1-3               | Test Voltage            | 1.5 × UR                                                                                                                 |
|     |           |               |                             | Test Time               | 1000 ± 12 h                                                                                                              |
|     |           |               |                             | Charge/discharge curren | ≤ 50 mA                                                                                                                  |
|     |           |               |                             | Post-treatment          | Perform a heat treatment at 150 °C + 0/-10 °C for 1hour and then sit for 24 ± 2 hours at room temperature. then measure. |
|     |           |               |                             |                         |                                                                                                                          |

Table 1-2: Electrical tests

| Series | Size | Temp.<br>Chara. | Rated<br>Voltage<br>(DC) | Thickness<br>Code | Capacitance | Electrical tests |             |                          |                               |
|--------|------|-----------------|--------------------------|-------------------|-------------|------------------|-------------|--------------------------|-------------------------------|
|        |      |                 |                          |                   |             | DF<br>[max]      | IR<br>[min] | Measurement<br>Frequency | Measurement<br>Voltage [Vrms] |
| B      | 0201 | X6S             | 6.3V                     | A                 | 100 nF      | 0.15             | 50fi·F      | 1.0±0.1KHz               | 1.0±0.2                       |

Table 1-3: Cap.¥ D.F¥ IR changes after test

| Series | Size | Temp.<br>Chara. | Rated<br>Voltage<br>(DC) | Thickness<br>Code | Capacitance | Resistance to<br>soldering<br>heat | Substrate<br>bending<br>test | Vibration                   | Rapid<br>change of<br>temperature | Damp heat, steady state     |             |             | High temperature high humidity<br>(steady) |             |             | Endurance                   |             |             |
|--------|------|-----------------|--------------------------|-------------------|-------------|------------------------------------|------------------------------|-----------------------------|-----------------------------------|-----------------------------|-------------|-------------|--------------------------------------------|-------------|-------------|-----------------------------|-------------|-------------|
|        |      |                 |                          |                   |             | Cap.<br>Change<br>[ΔC/C≤±%]        | Cap.<br>Change<br>[ΔC/C≤±%]  | Cap.<br>Change<br>[ΔC/C≤±%] | Cap.<br>Change<br>[ΔC/C≤±%]       | Cap.<br>Change<br>[ΔC/C≤±%] | DF<br>[max] | IR<br>[min] | Cap.<br>Change<br>[ΔC/C≤±%]                | DF<br>[max] | IR<br>[min] | Cap.<br>Change<br>[ΔC/C≤±%] | DF<br>[max] | IR<br>[min] |
| B      | 0201 | X6S             | 6.3V                     | A                 | 100 nF      | 15                                 | 12.5                         | 15                          | 15                                | 12.5                        | 0.2         | 25fi·F      | 12.5                                       | 0.2         | 25fi·F      | 15                          | 0.2         | 10fi·F      |

#### 4. Packaging, Shipment and storage

##### 4.1 Packaging

###### 4.1.1 packaging type

Reel Packaging (standard carrier tape disc packaging), single disc smallest package see ⑧ Packaging Code

First packaging: Each multi-disc material is packed into a box.

The second packaging: the first packaged packaging box is loaded into the paper packaging box, and the remaining space in the box is filled with light auxiliary materials.

The above packaging forms can also be packaged according to user needs.

###### 4.1.2 Carrier Tape size

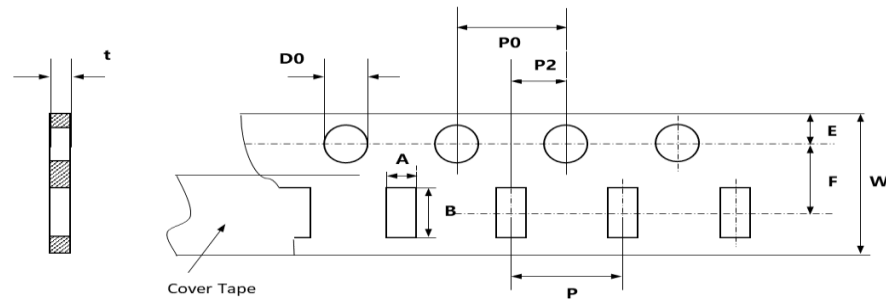


Fig. 5-1 0603, 0805, 1206, 1210 (Paper tape)

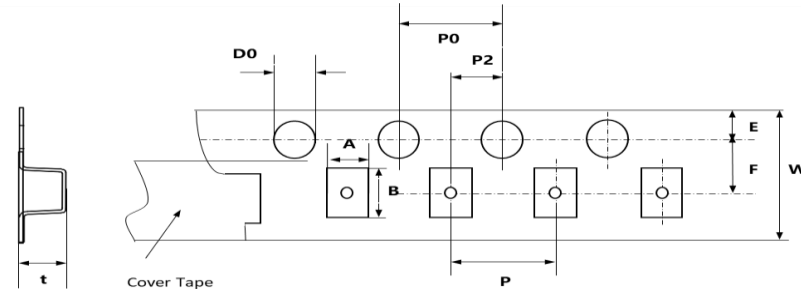


Fig. 5-2 0603, 0805, 1206, 1210 (Plastic tape)

Table 2-1: Carrier size (Size Code: 0603, 0805, 1206, 1210)

(Unit:mm)

| Size Code | Thickness code | Carrier Tape Type | Packaging Code | A           | B           | F           | P           | E           | D0          | P2          | K | W           | P0          | t        |
|-----------|----------------|-------------------|----------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|---|-------------|-------------|----------|
| 0603      | S              | Paper             | T              | 1.10 ± 0.10 | 1.90 ± 0.10 | 3.50 ± 0.05 | 4.00 ± 0.10 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | / | 8.00 ± 0.20 | 4.00 ± 0.10 | 0.70 max |
| 0603      | D              | Paper             | T              | 1.00 ± 0.10 | 1.80 ± 0.10 | 3.50 ± 0.05 | 4.00 ± 0.10 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | / | 8.00 ± 0.20 | 4.00 ± 0.10 | 1.15 max |
| 0603      | D              | Paper             | A              | 1.00 ± 0.10 | 1.80 ± 0.10 | 3.50 ± 0.05 | 4.00 ± 0.10 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | / | 8.00 ± 0.20 | 4.00 ± 0.10 | 1.15 max |
| 0603      | D              | Plastic           | O              | 1.00 ± 0.10 | 1.80 ± 0.10 | 3.50 ± 0.05 | 4.00 ± 0.10 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | / | 8.00 ± 0.20 | 4.00 ± 0.10 | 1.15 max |
| 0603      | D              | Paper             | W              | 1.00 ± 0.10 | 1.80 ± 0.10 | 3.50 ± 0.05 | 4.00 ± 0.10 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | / | 8.00 ± 0.20 | 4.00 ± 0.10 | 1.15 max |
| 0603      | K              | Paper             | T              | 1.10 ± 0.10 | 1.90 ± 0.10 | 3.50 ± 0.05 | 4.00 ± 0.10 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | / | 8.00 ± 0.20 | 4.00 ± 0.10 | 1.15 max |
| 0603      | K              | Paper             | A              | 1.10 ± 0.10 | 1.90 ± 0.10 | 3.50 ± 0.05 | 4.00 ± 0.10 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | / | 8.00 ± 0.20 | 4.00 ± 0.10 | 1.15 max |
| 0603      | K              | Plastic           | O              | 1.10 ± 0.10 | 1.90 ± 0.10 | 3.50 ± 0.05 | 4.00 ± 0.10 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | / | 8.00 ± 0.20 | 4.00 ± 0.10 | 1.15 max |
| 0603      | K              | Paper             | W              | 1.10 ± 0.10 | 1.90 ± 0.10 | 3.50 ± 0.05 | 4.00 ± 0.10 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | / | 8.00 ± 0.20 | 4.00 ± 0.10 | 1.15 max |
| 0603      | K              | Plastic           | Q              | 1.10 ± 0.10 | 1.90 ± 0.10 | 3.50 ± 0.05 | 4.00 ± 0.10 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | / | 8.00 ± 0.20 | 4.00 ± 0.10 | 1.15 max |
| 0603      | K              | Plastic           | R              | 1.10 ± 0.10 | 1.90 ± 0.10 | 3.50 ± 0.05 | 4.00 ± 0.10 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | / | 8.00 ± 0.20 | 4.00 ± 0.10 | 1.15 max |
| 0603      | W              | Plastic           | R              | 1.10 ± 0.20 | 1.90 ± 0.20 | 3.50 ± 0.05 | 4.00 ± 0.10 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | / | 8.00 ± 0.20 | 4.00 ± 0.10 | 1.35 max |
| 0603      | W              | Plastic           | O              | 1.10 ± 0.20 | 1.90 ± 0.20 | 3.50 ± 0.05 | 4.00 ± 0.10 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | / | 8.00 ± 0.20 | 4.00 ± 0.10 | 1.35 max |
| 0603      | W              | Plastic           | Q              | 1.10 ± 0.20 | 1.90 ± 0.20 | 3.50 ± 0.05 | 4.00 ± 0.10 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | / | 8.00 ± 0.20 | 4.00 ± 0.10 | 1.35 max |

(Unit:mm)

SPEC-CAB20240801

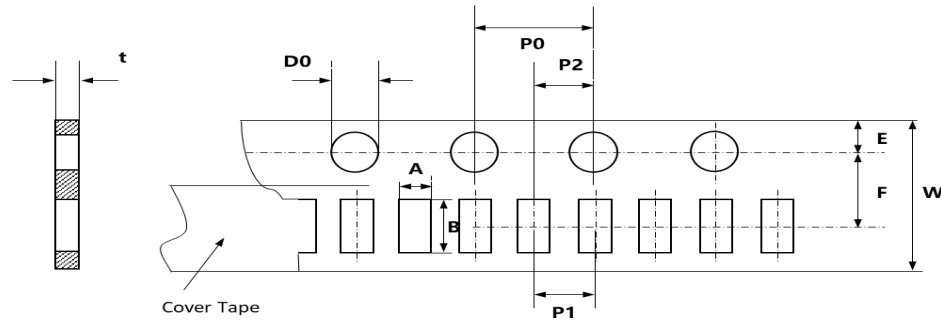


Fig. 5-3 0402 (Paper tape/ 2 mm pitch)

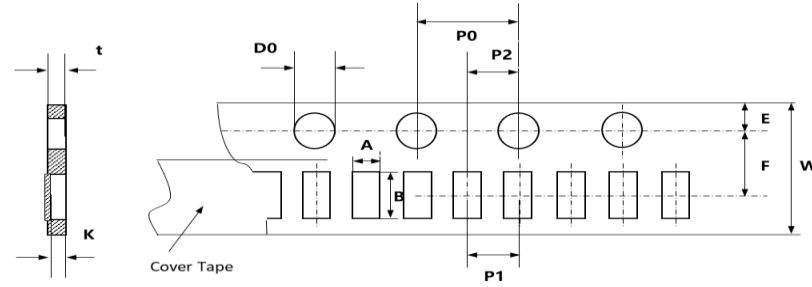


Fig. 5-4 0105, 0201 (Paper tape/ 2 mm pitch)

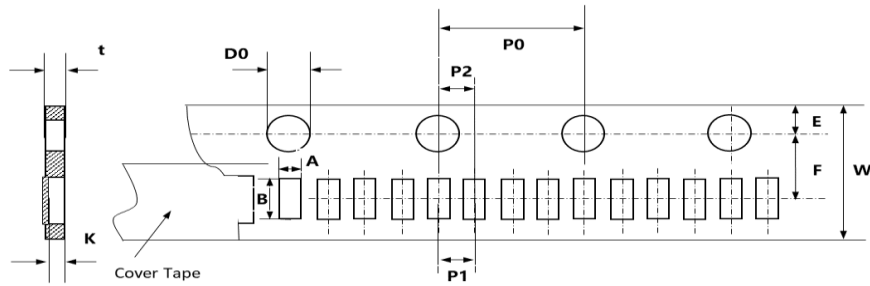


Fig. 5-5 0201 (Paper tape/ 1 mm pitch)

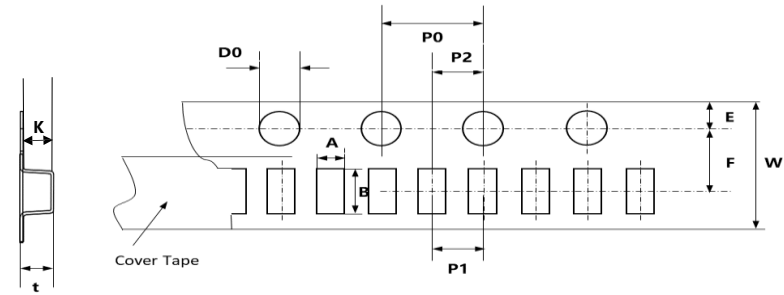


Fig. 5-6 0105 (Plastic tape/ 1 mm pitch)

Table 2-2: Carrier size (Size Code:0105,0201,0402)

(Unit:mm)

| Size Code | Thickness code | Carrier Tape Type | Packaging Code | A           | B           | F           | P1          | E           | D0          | P2          | K           | W           | P0          | t       |
|-----------|----------------|-------------------|----------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|---------|
| 0105      | Z              | Paper             | T              | 0.24 ± 0.02 | 0.45 ± 0.02 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.24 ± 0.02 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max |
| 0105      | Z              | Paper             | H              | 0.24 ± 0.02 | 0.45 ± 0.02 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.24 ± 0.02 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max |
| 0105      | Z              | Plastic           | P              | 0.24 ± 0.02 | 0.45 ± 0.02 | 1.80 ± 0.05 | 1.00 ± 0.05 | 0.90 ± 0.10 | 0.80 ± 0.05 | 1.00 ± 0.05 | 0.24 ± 0.02 | 4.00 ± 0.10 | 2.00 ± 0.10 | 0.5 max |
| 0201      | A              | Paper             | T              | 0.38 ± 0.03 | 0.68 ± 0.03 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.36 ± 0.02 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max |
| 0201      | A              | Paper             | J              | 0.38 ± 0.03 | 0.68 ± 0.03 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.36 ± 0.02 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max |
| 0201      | A              | Paper             | D              | 0.38 ± 0.03 | 0.68 ± 0.03 | 3.50 ± 0.05 | 1.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 1.00 ± 0.05 | 0.36 ± 0.02 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max |
| 0201      | A              | Paper             | A              | 0.38 ± 0.03 | 0.68 ± 0.03 | 3.50 ± 0.05 | 1.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 1.00 ± 0.05 | 0.36 ± 0.02 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max |
| 0201      | A              | Paper             | M              | 0.38 ± 0.03 | 0.68 ± 0.03 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.36 ± 0.02 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max |

Table 2-2: Carrier size (Size Code:0105,0201,0402)

(Unit:mm)

| Size Code | Thickness code | Carrier Tape Type | Packaging Code | A           | B           | F           | P1          | E           | D0          | P2          | K           | W           | P0          | t        |
|-----------|----------------|-------------------|----------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|----------|
| 0201      | A              | Paper             | H              | 0.38 ± 0.03 | 0.68 ± 0.03 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.36 ± 0.02 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max  |
| 0201      | A              | Paper             | L              | 0.38 ± 0.03 | 0.68 ± 0.03 | 3.50 ± 0.05 | 1.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 1.00 ± 0.05 | 0.36 ± 0.02 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max  |
| 0201      | J              | Paper             | T              | 0.40 ± 0.04 | 0.70 ± 0.04 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.38 ± 0.04 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max  |
| 0201      | J              | Paper             | J              | 0.40 ± 0.04 | 0.70 ± 0.04 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.38 ± 0.04 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max  |
| 0201      | J              | Paper             | D              | 0.40 ± 0.04 | 0.70 ± 0.04 | 3.50 ± 0.05 | 1.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 1.00 ± 0.05 | 0.38 ± 0.04 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max  |
| 0201      | J              | Paper             | A              | 0.40 ± 0.04 | 0.70 ± 0.04 | 3.50 ± 0.05 | 1.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 1.00 ± 0.05 | 0.38 ± 0.04 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max  |
| 0201      | J              | Paper             | M              | 0.40 ± 0.04 | 0.70 ± 0.04 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.38 ± 0.04 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max  |
| 0201      | J              | Paper             | H              | 0.40 ± 0.04 | 0.70 ± 0.04 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.38 ± 0.04 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max  |
| 0201      | J              | Paper             | L              | 0.40 ± 0.04 | 0.70 ± 0.04 | 3.50 ± 0.05 | 1.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 1.00 ± 0.05 | 0.38 ± 0.04 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.5 max  |
| 0201      | X              | Paper             | T              | 0.44 ± 0.06 | 0.74 ± 0.06 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.40 ± 0.05 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.6 max  |
| 0201      | X              | Paper             | J              | 0.44 ± 0.06 | 0.74 ± 0.06 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.40 ± 0.05 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.6 max  |
| 0201      | X              | Paper             | H              | 0.44 ± 0.06 | 0.74 ± 0.06 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.40 ± 0.05 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.6 max  |
| 0201      | F              | Paper             | T              | 0.44 ± 0.06 | 0.74 ± 0.06 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.40 ± 0.05 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.6 max  |
| 0201      | B              | Paper             | H              | 0.44 ± 0.06 | 0.74 ± 0.06 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.55 ± 0.05 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.7 max  |
| 0201      | B              | Paper             | T              | 0.44 ± 0.06 | 0.74 ± 0.06 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | 0.55 ± 0.05 | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.7 max  |
| 0402      | B              | Paper             | T              | 0.63 ± 0.05 | 1.13 ± 0.05 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | /           | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.8 max  |
| 0402      | B              | Paper             | J              | 0.63 ± 0.05 | 1.13 ± 0.05 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | /           | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.8 max  |
| 0402      | N              | Paper             | T              | 0.70 ± 0.10 | 1.20 ± 0.10 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | /           | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.8 max  |
| 0402      | N              | Paper             | J              | 0.70 ± 0.10 | 1.20 ± 0.10 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | /           | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.8 max  |
| 0402      | C              | Paper             | T              | 0.75 ± 0.10 | 1.30 ± 0.10 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | /           | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.8 max  |
| 0402      | C              | Paper             | J              | 0.75 ± 0.10 | 1.30 ± 0.10 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | /           | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.8 max  |
| 0402      | U              | Paper             | C              | 0.85 ± 0.10 | 1.40 ± 0.10 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | /           | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.95 max |
| 0402      | U              | Paper             | T              | 0.85 ± 0.10 | 1.40 ± 0.10 | 3.50 ± 0.05 | 2.00 ± 0.05 | 1.75 ± 0.10 | 1.55 ± 0.05 | 2.00 ± 0.05 | /           | 8.00 ± 0.10 | 4.00 ± 0.10 | 0.95 max |

4.1.3 Disc size

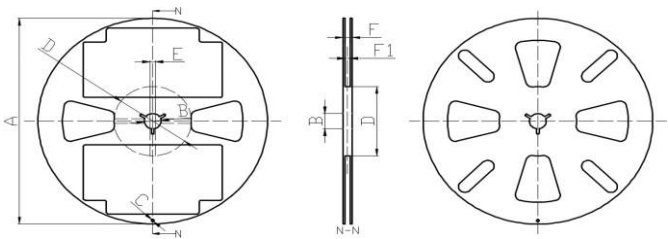


Fig. 6-1 Disc (Width of carrier-4 mm)

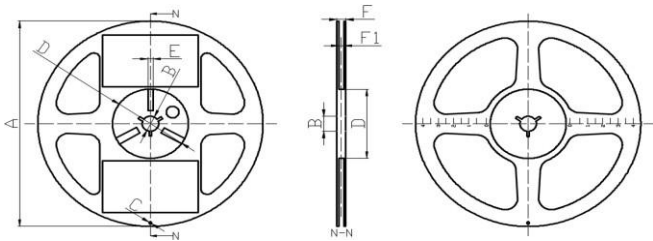


Fig. 6-2 Disc (Width of carrier-8 mm)

Table 3: Disc size

| (Unit:mm) |                  |            |           |            |            |           |            |            |           |
|-----------|------------------|------------|-----------|------------|------------|-----------|------------|------------|-----------|
| Disc size | Width of carrier | A          | B         | C          | D          | E         | F          | F1         | Size Code |
| 7"        | 8.00 ± 0.10      | Φ178 ± 2.0 | Φ13 ± 1.0 | Φ4.0 ± 0.5 | Φ60 ± 2.0  | 4.0 ± 1.0 | 11.5 ± 1.0 | 10.0 ± 2.0 | All       |
| 13"       | 8.00 ± 0.10      | Φ330 ± 2.0 | Φ13 ± 1.0 | Φ4.0 ± 0.5 | Φ108 ± 2.0 | 4.0 ± 1.0 | 13.5 ± 2.0 | 10.0 ± 2.0 | All       |
| 7"        | 4.00 ± 0.10      | Φ178 ± 2.0 | Φ13 ± 1.0 | Φ4.0 ± 0.5 | Φ60 ± 2.0  | 3.5 ± 0.5 | 7.3 ± 0.5  | 4.5 ± 1.0  | 0105      |

4.1.4 Carrier Tape specifications

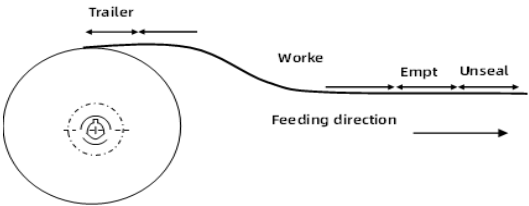


Fig. 7 Carrier

| Packaging | The minimum length of the reserved spaces |        |        |
|-----------|-------------------------------------------|--------|--------|
|           | Trailer                                   | Empty  | Unseal |
| Carrier   | 60 mm                                     | 200 mm | 160 mm |

#### 4.1.5 Performance of Carrier Taping

##### 4.1.5.1 Strength of Carrier Tape and Top Cover Tape

###### a. Carrier Tape

When a tensile force 1.02 kgf is applied in the direction to unreel the tape, the tape shall withstand this force.

###### b. Top cover Tape

When a tensile force 1.02 kgf is applied to the tape, the tape shall withstand this force.

##### 4.1.5.2 Peeling Strength of Top Cover Tape

Unless otherwise specified, the peeling strength of top cover tape shall be within 10.2 gf to 71.4 gf when the top cover tape is pulled at a speed of 300 mm/min with the angle of 0° to 15° (see Fig.8).

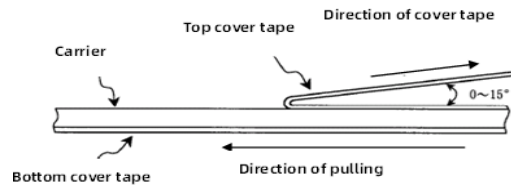


Fig.8 Cover tape peel-off force

## 2. Shipment

Transport packaging products to adapt to the modern means of transport, but the product in the process of transport to prevent rain and acid and alkali corrosion, shall not be whipped extrusion casting and gravity.

## 3. Storage

### 1. Storage conditions:

The recommended temperature is less than 30 °C.

A temperature is 5 °C to 40 °C and a relative humidity is 20% to 70% as a standard condition.(MSL Level 1)

MLCC may be affected by the storage conditions. Please use them promptly after delivery.

High temperature and humidity conditions and/or prolonged storage may cause deterioration of the packaging materials.

If more than one year has elapsed since delivery, also check the solderability before use.

### 2. Corrosive gas can react with the termination (external) electrodes or lead wires of capacitors, and result in poor solderability.

Do not store the capacitors in an atmosphere consisting of corrosive gas (e.g.,hydrogen sulfide, sulfur dioxide, chlorine, ammonia gas etc.)

## 5. MLCC Application of Technical Requirements

### 5.1 Circuit Design

#### 5.1.1 Operating Temperature

- Do not use capacitor above the maximum allowable operating temperature.
- Surface temperature including self-heating should be below maximum operating temperature.

#### 5.1.2 Operating Voltage

The operating voltage for capacitors must always be lower than their rated voltage.

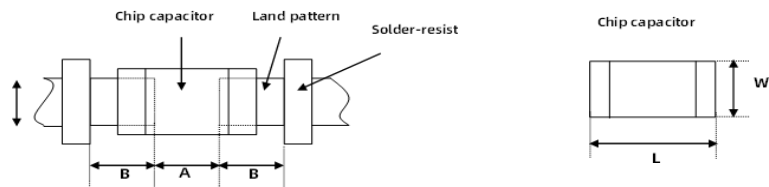
### 5.2 PCB Design

#### 5.2.1 Design of Land-patterns

When the capacitors are mounted on a PCB, the amount of solder at the terminations has a direct effect on the performance of the capacitors.

The greater the amount of solder, the higher the stress on the capacitor. Therefore, when designing land-patterns, it is necessary to consider the appropriate size and configuration of the solder pads.

Size and recommended land dimensions are shown in the following figure and table.



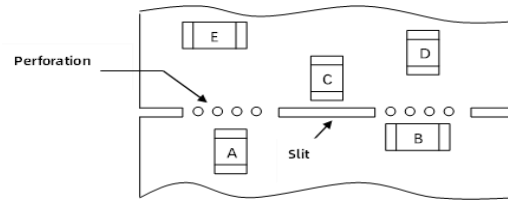
Recommended land dimensions for reflow-soldering

(unit: mm)

| Size Code | Length | Width | Tolerance                      | A         | B         | C         |
|-----------|--------|-------|--------------------------------|-----------|-----------|-----------|
| 0105      | 0.4    | 0.2   | all                            | 0.16-0.20 | 0.12-0.18 | 0.20-0.23 |
| 0201      | 0.6    | 0.3   | $\pm 0.03$                     | 0.20-0.25 | 0.20-0.30 | 0.20-0.35 |
| 0201      | 0.6    | 0.3   | $\pm 0.05$                     | 0.20-0.25 | 0.25-0.35 | 0.30-0.40 |
| 0201      | 0.6    | 0.3   | $\pm 0.09, \pm 0.1$            | 0.23-0.30 | 0.25-0.35 | 0.30-0.40 |
| 0402      | 1.0    | 0.5   | $\pm 0.05$                     | 0.30-0.50 | 0.35-0.45 | 0.40-0.60 |
| 0402      | 1.0    | 0.5   | $\pm 0.15, \pm 0.20$           | 0.40-0.60 | 0.40-0.50 | 0.50-0.70 |
| 0402      | 1.0    | 0.5   | $\pm 0.30$                     | 0.40-0.60 | 0.40-0.50 | 0.50-0.80 |
| 0603      | 1.6    | 0.8   | $\pm 0.10$                     | 0.60-0.80 | 0.60-0.70 | 0.60-0.80 |
| 0603      | 1.6    | 0.8   | $\pm 0.20$                     | 0.70-0.90 | 0.70-0.80 | 0.80-1.00 |
| 0603      | 1.6    | 0.8   | $\pm 0.25, \pm 0.30$           | 0.70-0.90 | 0.70-0.90 | 0.80-1.10 |
| 0805      | 2.0    | 1.25  | $\pm 0.10, \pm 0.15, \pm 0.20$ | 1.00-1.40 | 0.60-0.80 | 1.20-1.40 |
| 0805      | 2.0    | 1.25  | $\pm 0.25$                     | 1.00-1.40 | 0.70-0.90 | 1.35-1.55 |
| 1206      | 3.2    | 1.6   | $\pm 0.15, \pm 0.20$           | 1.80-2.00 | 0.90-1.20 | 1.50-1.70 |
| 1206      | 3.2    | 1.6   | $\pm 0.30$                     | 1.90-2.10 | 1.00-1.30 | 1.60-1.90 |
| 1210      | 3.2    | 2.5   | $\pm 0.20$                     | 2.00-2.40 | 1.00-1.20 | 2.50-2.70 |
| 1210      | 3.2    | 2.5   | $\pm 0.30$                     | 2.00-2.40 | 1.10-1.30 | 2.50-2.80 |

### 5.2.2 Capacitor Layout on PC Board

Mechanical stress varies according to the location of capacitors on PC board. The recommendation for better design is as follows

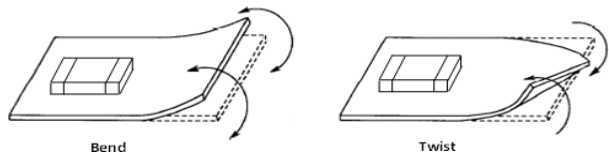


The stress in capacitors is in the following order:  $A > B = C > D > E$

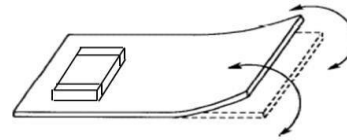
Pay attention not to bend or distort the PC board otherwise the capacitor may crack.

Please refer to the following examples of good and bad capacitors layout.

a. Not recommended

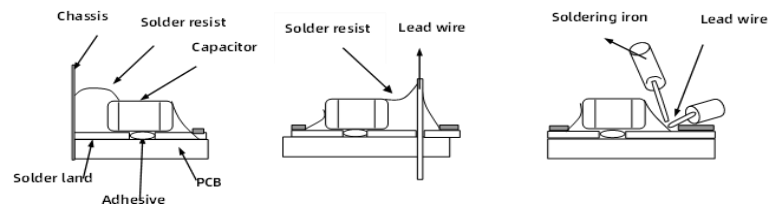


b. Recommended

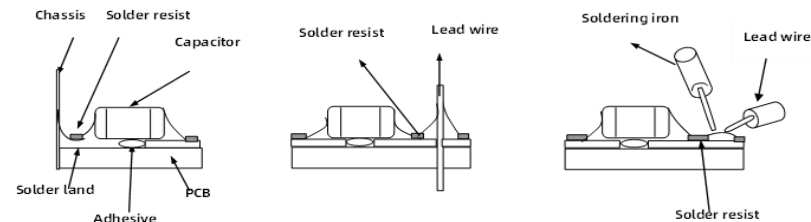


### 5.2.3 Solder Buildup and Soldering

a. Examples of soldering method not recommended



b. Examples of soldering method recommended

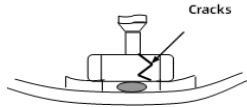
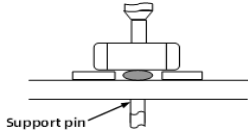
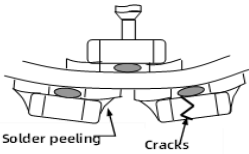
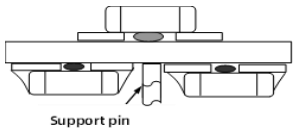


5.3 Consideration for Automatic Placement

If the mounting head is adjusted too low, it may induce excessive stress in the chip capacitor to result in cracking. Please take following precautions

- a. Adjust the bottom dead center of the mounting head to reach on the PC board surface and not press it ;
- b. Adjust the mounting head pressure to be 1N to 3N of static weight ;
- c. To minimize the impact energy from mounting head, it is important to provide support from the bottom side of the PC board.

Please refer to the following samples

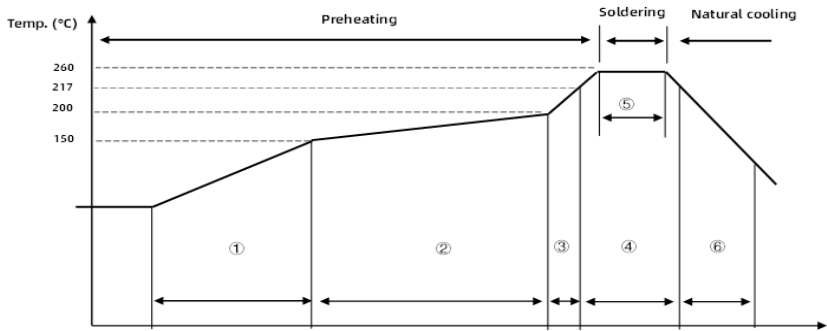
| Mounting              | Not recommended                                                                   | Recommended                                                                         |
|-----------------------|-----------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|
| Singel-sided Mounting |  |  |
| Double-sided Mounting |  |  |

4. Soldering

1. Flux Selection

- a. It is recommended to use a mildly activated rosin flux (less than 0.1wt% chlorine). Strong flux is not recommended.
- b. Please provide proper amount of flux. Excessive flux must be avoided.
- c. When water-soluble flux is used, enough washing is necessary.

5.4.2 Recommended Soldering Profile

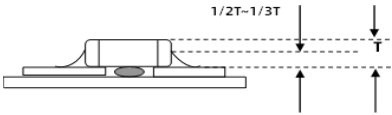


5.4.2.1 Reflow Soldering Condition

| NO. | Reflow Soldering zone | Reflow Soldering Condition                                                                            |
|-----|-----------------------|-------------------------------------------------------------------------------------------------------|
| ①   | Preheating 1          | $\leq 3\text{ }^{\circ}\text{C/s}, \geq 60\text{ s}$                                                  |
| ②   | Constant temperature  | $150^{\circ}\text{C}-200^{\circ}\text{C}, 60\text{ s}-120\text{ s}, \leq 1\text{ }^{\circ}\text{C/s}$ |
| ③   | Preheating 1          | $1-5\text{ }^{\circ}\text{C/s}$                                                                       |
| ④   | Soldering 1           | Above $217\text{ }^{\circ}\text{C}, 60-150\text{ s}$                                                  |
| ⑤   | Soldering 1           | Above $260\text{ }^{\circ}\text{C}, \text{over } 10\text{ s}$                                         |
| ⑥   | Natural cooling       | $\leq 6\text{ }^{\circ}\text{C/s}$                                                                    |

Caution

a. Excessive solder will induce higher tensile force in chip capacitor when temperature changes and result in cracking. Insufficient solder may detach the capacitor from the PC board. The ideal condition is to have solder mass controlled to 1/2 to 1/3 of the thickness of the capacitors.



- b. Soldering duration should be kept as close to recommended times as possible, because excessive duration can detrimentally affect solderability.
- c. The peak temperature of reflow soldering is  $245\text{ }^{\circ}\text{C} \pm 15\text{ }^{\circ}\text{C}$ .

6. All products in this specification comply with the EU RoHS directive

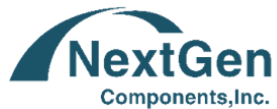
The EU RoHS Directive refers to the "Directive 2011/65/EU on the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment" stipulated by the European Union.



|                           |                                                             |
|---------------------------|-------------------------------------------------------------|
| PRODUCT NAME:             | Industrial Grade MLCC B Series SMD 0201 X6S 100nF ±10% 6.3V |
| REVISION:                 | A3                                                          |
| NEXTGEN ORDER PART CODE*: | B0201S104K6R3A                                              |
| CROSS REF. PART NO.:      |                                                             |
| ORIGINAL MFG PART NO.:    | B0201X6S104K6R3NTA                                          |
| ORIGINAL MANUFACTURER:    | EYang Technology/Eyang MLCC                                 |

*Image shown is a representation only.  
Exact specifications should be obtained  
from the product dimension*

*\*: Please Indicate this Part Code For RFQ/Order Support*



#### AUTHORIZED DISTRIBUTOR

NextGen Components, Inc.

US Warehouse Location: 9 Orchard Road, Suit 106, Lake Forest, CA 92630, USA

RFQ/Order Support: [sales@NextGenComponent.com](mailto:sales@NextGenComponent.com)

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## HOW TO ORDER

Please Follow Up Part Code Guide And Indicate NextGen Part Code B0201S104K6R3A For RFQ and new Order.**RFQ**  
[Request For Quotation](#)

| CODE | NAME                        | KEY SPECIFICATION OPTION                                                                                                                                                                                  |
|------|-----------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B    | Series Code                 | B: Industrial Grade Multilayer Ceramic Chip Capacitors                                                                                                                                                    |
| 0201 | Case Size                   | 0105 : L0.40*W0.20mm; 0201 : L0.60*W0.30mm; 0402 : L1.00*W0.50mm; 0603 : L1.60*W0.80mm<br>0805 : L2.00*W1.25mm; 1206 : L3.20*W1.60mm; 1210 : L3.20*W2.50mm                                                |
| S    | Temperature Characteristics | N: NP0 (COG); B: X7R; W: X5R; S: X6S; Y: Y5V; T: X7S; R: X7T                                                                                                                                              |
| 104  | Capacitance                 | Two significant digits followed by number of Zero, The 3rd digit signifies the multiplying factor, and letter R is decimal point.<br>8R2: 8.2pF; 820: 82pF; 104: 100nF; 680: 68pF; 471: 470pF; 475: 4.7μF |
| K    | Capacitance Tolerance       | A: ±0.05pF; B: ±0.1pF; C: ±0.25pF; D: ±0.5pF; F: ±1%; G: ±2%; J: ±5%; K: ±10%<br>L: ±15%; M: ±20%; N: ±30%; P: ±0.02pF; X: ±40%; S: 50%/-20%; Y: 150%/-20% Z: 80%/-20%                                    |
| 6R3  | Rated Voltage               | Two significant digits followed by No. of zeros. "R" is in place of decimal point.<br>6R3: 6.3VDC; 160: 16 VDC; 250: 25 VDC; 100: 10 VDC; 500: 50 VDC; 101: 100VDC                                        |
| A    | Case Thickness              | A: 0.5mm Max, See Page 8 (T's Symbol) for Different part code                                                                                                                                             |
| XX   | Internal Control Code       | Blank: N/A; XX: Letter A~Z, a~z or digits (0~9) for Special/Custom Parameters                                                                                                                             |

## IMPORTANT NOTES AND DISCLAIMER

1. ROHS COMPLIANCE: The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for this product can be obtained can be obtained at Download Center.
2. REACH COMPLIANCE: REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, REACH Test Report for this product can be obtained can be obtained at Download Center.
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